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Docket No. XA-10840

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Office: Please record the attached documents or the new address(es) below.

1. ENOMOTO, Hiroyuki  
HAYANO, Katsuya  
MACHIDA, Shuntaro

Execution Date(s): June 11, 2007, June 20, 2007, June 13, 2007

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License  
☐ Other \_\_\_\_\_

2. Name and address of receiving party(ies)

Name: Hitachi, Ltd.

Address: 6-6 Marunouchi 1 chome, Chhiyoda-ku

City: Tokyo

State: \_\_\_\_\_

Country: Japan Zip: \_\_\_\_\_

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No.(s)

11/767,602, Filed June 25, 2007

☐ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Mitchell W. Shapiro

Registration No.: 31,568

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City: McLean

State: Virginia Zip: 22102

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6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged to deposit account  
☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

8. Payment Information

a. Credit Card Last 4 Numbers \_\_\_\_\_

Expiration Date \_\_\_\_\_

b. Deposit Account Number 50-1165

Authorized User Name Mitchell W. Shapiro

9. Signature: Mitchell W. Shapiro

Mitchell W. Shapiro

Name of Person Signing

Date August 8, 2007

Total Number of pages including cover sheet, attachments, and documents: 2

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Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

# ASSIGNMENT

( 譲渡証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo 100-8280, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE AND SEMICONDUCTOR DEVICE

invented by me (if only one is named below ) or us (if plural inventors are named below ) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside signatures:

INVENTOR(S)

(発明者フルネームサイン)

Date Signed

(署名日)

1) Hiroyuki Enomoto (Hiroyuki ENOMOTO)

6/11/2007

2) Katsuya Hayano (Katsuya HAYANO)

6/20/2007

3) Shuntaro Machida (Shuntaro MACHIDA)

6/13/2007

4) \_\_\_\_\_

\_\_\_\_\_

5) \_\_\_\_\_

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6) \_\_\_\_\_

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7) \_\_\_\_\_

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8) \_\_\_\_\_

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